

PRODUCT BROCHURE

IR Light Wafer Inspection Microscope

Silicon is highly transparent to infrared (IR) light. The idonus IR light wafer inspection microscope (IRM) illuminates the silicon-based substrate from the back side and captures the light that passes through it.



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IR Light Wafer Inspection Microscope

General Information

Silicon is transparent for infrared light. Our IR light wafer inspection microscope illuminates the silicon substrate from the back-side and captures the light that permeates the substrate. Therefore, it becomes possible to inspect phenomena inside the silicon substrate, which are not visible with a conventional microscope.

The microscope is equipped with a long working distance objective. A three step zoom allows the user to choose the right field of view and magnification. An IR sensitive camera displays the image of the inspected device via USB on your computer. The resolution is better than 3 μ m with a 5x objective.

Additionally, a top side illumination is available. This allows the use of the microscope in a conventional mode and the inspection of the top side of the wafer.

The IR microscope is equipped with a xy-table, which accommodates 8" or smaller wafers. The table is motor driven and can be controlled with a joystick. For laboratory environment the IR-microscope can be equipped with a cost effective manual XY-translation table instead of the fully automated device. Please contact us for further details!



Features of the IR microscope:

- · Back-side IR illumination
- Top-side illumination
- xy-table for 8" wafers or smaller
- Long working distance objective
- 3 step zoom
- IR-sensitive camera
- Inspection on computer



IR wafer inspection microscope equipped with top- and back-side illumination, which enables the inspection of phenomena inside the silicon substrate as well as the usage as a conventional microscope.



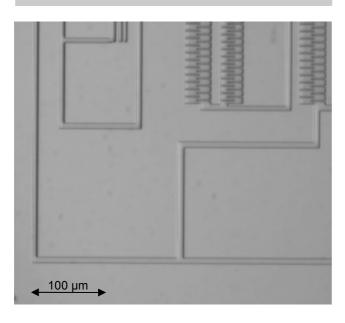
Control of IR and visible illumination intensity: The microscope can be used for Infrared imaging as well as a regular microscope with visual light illumination from the top-side

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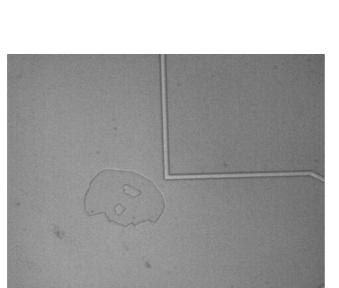
Applications & Benefits

Applications:

- Inspection of released MEMS devices
- Measurement of etching speed of buried materials (e.g. SOI wafers)
- Inspection of fusion bonding
- Back-side alignment of silicon wafers/chips
- Quality control



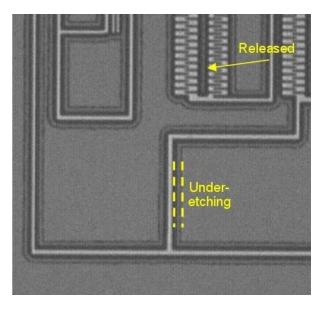
Top view of a part of a microstructure fabricated on a silicon-on-insulator (SOI) wafer.



Inspection of silicon fusion bonding: In this case, a DRIE-structured wafer was fusion bonded to another wafer. Any failures such as voids or alignements can be visualized by IR-light.

Benefits:

- Reliable fabrication of smaller anchors for MEMS yields higher fill factors
- Top- & back-side illumination
- High resolution (< 3 µm with 5x objective)
- Small footprint
- Easy to use, immediate results



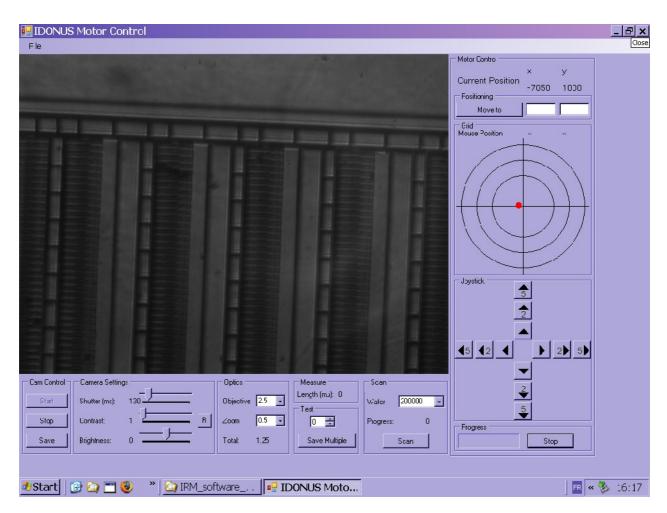
Infrared image of the same area after 60 minutes of HF vapor phase etching. The under-etching of the buried ${\rm SiO}_2$ becomes visible, which enables the determination of released and non released parts.



IR-Microscope with cost effictive manual XY-translation table for laboratory use.

IR Light Wafer Inspection Microscope

Graphical User Interface

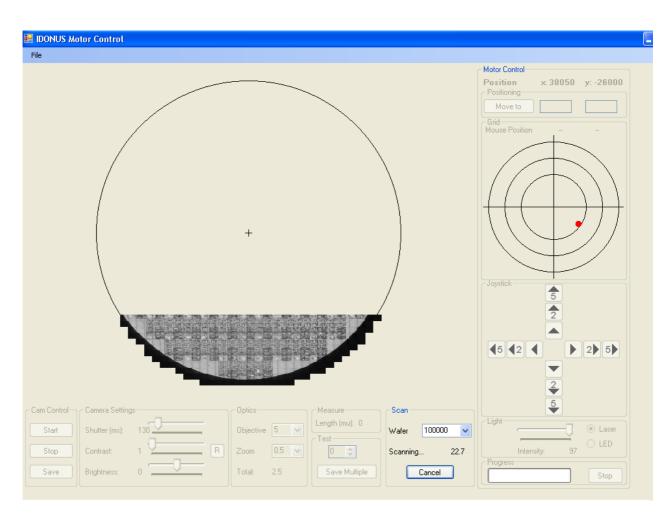


A graphical user interface for Windows allows the user to operate the microscope with a PC. It enables complete control of the microscope as well as an automated acquisition of images on a user defined grid on the wafer.

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IR Light Wafer Inspection Microscope

Graphical User Interface



The high resolution image of a complete wafer can be acquired automatically taking multiple pictures of the wafer. The images are stitched to a large image and stored to your disk drive.

Contact

Idonus Sarl Rouges-Terres 61 2068 Hauterive / NE Switzerland

Phone: +41 32 724 44 40 Fax: +41 32 724 44 42 Email: info@idonus.com Web: www.idonus.com brication

IR Light Wafer Inspection Microscope

Technical Specifications – automated version

Product Code	IRM 200 – auto
Wafer sizes	200 mm (8"); 100 mm / 150 mm can also be inspected
xy-table displacement	200 x 200 mm
xy-table	Motor driven, controlled with joystick
Optical resolution	Better then 3 µm with 5x objective
Working distance	32 mm
Magnification	2.5x; 5x; 10x (with 5x objective)
FOV	2.5 mm x 2.0 mm (2.5x magnification)
Zoom	3 step zoom: 0.5x / 1x / 2x
Camera	B&W with USB 2 output
Resolution	1.4 Megapixel
IR light source wavelength	1 μm
Power	110 to 230 VAC, 50 to 60 Hz
Power consumption	160 VA
Dimensions (I x w x h)	700 x 470 x 650 mm ³
Weight	40 kg
Footprint	700 x 470 mm ²
Software	Driver for Image acquisition
	Frame grabber
Additional requirements	PC or Laptop with USB 2 interface
for installation	(Windows XP or 2000)
Optional	
Objectives	2.5x / 5x (included) / 10x / 20x
Wafer adapter rings	For 100 and 150 mm
Graphical user interface	For easy handling and full wafer scan
Software for pattern recognition	On request available

Note: This IR-Microscope can be used for wafers with a diameter of 100, 150 or 200 mm.

Contact

Idonus Sarl Rouges-Terres 61 2068 Hauterive / NE

Switzerland Phone: +41 32 724 44 40

Fax: +41 32 724 44 42 Email: info@idonus.com Web: www.idonus.com

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IR Light Wafer Inspection Microscope

Technical Specifications - manual version

Product Code	IRM 100 – man
Wafer sizes	100 mm (4"); 150 mm / 200 mm can also be inspected
xy-table displacement	100 x 100 mm
xy-table	manual
Optical resolution	Better then 3 µm with 5x objective
Working distance	32 mm
Magnification	2.5x; 5x; 10x (with 5x objective)
FOV	2.5 mm x 2.0 mm (2.5x magnification)
Zoom	3 step zoom: 0.5x / 1x / 2x
Camera	B&W with USB 2 output
Resolution	1.4 Megapixel
IR light source wavelength	1 μm
Power	110 to 230 VAC, 50 to 60 Hz
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Objectives	2.5x / 5x (included) / 10x / 20x
Wafer adapter rings	For 100 and 150 mm
Graphical user interface	For easy handling and full wafer scan
Software for pattern recognition	On request available

Note: This IR-Microscope is designed to use for wafers with a diameter of 100 mm or smaller. Wafers with 150 or 200 mm can be inspected but the table translation is limited.

Contact

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Switzerland

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